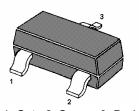
N-Channel Enhancement Vertical D-MOS Transistor

Features

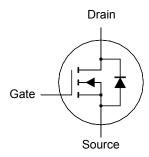
- · High-speed switching
- No secondary breakdown

Applications

- Thin and thick film circuits
- General purpose fast switching applications



1. Gate 2. Source 3. Drain SOT-23 Plastic Package



Absolute Maximum Ratings (T_a = 25 °C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	50	V
Gate-Source Voltage (open drain)	V_{GSO}	± 20	V
Drain Current	I _D	100	mA
Peak Drain Current	I _{DM}	300	mA
Total Power Dissipation	P _{tot} 1)	300	mW
	P _{tot} ²⁾	250	mW
Junction Temperature	T _j	150	°C
Storage Temperature Range	T _s	- 65 to + 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Juntion to Ambient	$R_{ heta JA}$	430 ¹⁾	K/W
	$R_{ heta JA}$	500 ²⁾	K/W

¹⁾ Device mounted on a ceramic substrate 10 X 8 X 0.7 mm.









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²⁾ Device mounted on a printed-circuit board.

MMFTN20

Characteristics at $T_a = 25$ °C unless otherwise specified

Parameter	Symbol	Min.	Max.	Unit
Drain-Source Breakdown Voltage at $I_D = 10 \mu A$	V _{(BR)DSS}	50	-	V
Drain-Source Leakage Current at V _{DS} = 40 V	I _{DSS}	-	1	μΑ
Gate-Source Leakage Current at V _{GS} = ± 20 V	I _{GSS}	-	± 100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$	$V_{GS(th)}$	0.4	1.8	V
Drain-Source On-State Resistance at V_{GS} = 10 V, I_D = 100 mA at V_{GS} = 5 V, I_D = 100 mA at V_{GS} = 2.5 V, I_D = 10 mA	R _{DS(on)}	- - -	15 20 30	Ω
Forward Transfer Admittance at V_{DS} = 10 V, I_D = 100 mA	y _{fs}	40	-	mS
Input Capacitance at V_{DS} = 10 V, f = 1 MHz	C _{iss}	-	15	pF
Output Capacitance at V_{DS} = 10 V, f = 1 MHz	C _{oss}	-	15	pF
Reverse Transfer Capacitance at V_{DS} = 10 V, f = 1 MHz	C _{rss}	-	5	pF
Turn-On Time at V_{GS} = 0 to 10 V, V_{DD} = 20 V, I_D = 100 mA	t _(on)	-	5	ns
Turn-Off Time at V_{GS} = 10 to 0 V, V_{DD} = 20 V, I_D = 100 mA	t _(off)	-	10	ns









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